



DOCUMENT CHANGE REQUEST

DCR number	470	Changes required for:	General	Originator:	Steve Thacker - ESCC
Date:	2009/02/06	Date sent:	2009/02/06	Organisation:	ESA/ESTEC
Status:	IMPLEMENTED				

Title: Resistors Fixed Chip Thick Film Based on Type CHP

Number: 4001/026 Issue: 2

Other documents affected:

Page:

Specification 4001/026 issue 2 is re-written as issue 3 to incorporate changes resulting from the modification of ESCC Generic specification No. 4001 (per approved DCR409), as summarised herein.
(see Attached for proposed 4001/026 issue 3 Draft A).

The

Paragraph:

Specification 4001/026 issue 2 is re-written as issue 3 to incorporate changes resulting from the modification of ESCC Generic specification No. 4001 (per approved DCR409), as summarised herein.
(see Attached for proposed 4001/026 issue 3 Draft A).

The

Original wording:

Proposed wording:

Total reformat of this Detail Specification (from the range of various ESCC Detail Specifications, 4001/xxx, for resistors under Generic Specification No. 4001) as part of the ongoing conversion to the ESCC format.
See below for summary of changes, also see attached proposed 4001/026 Issue 3 Draft A.

Note: known support for active procurement against this specification includes the following Manufacturer:
Vishay SA Sfernice/France (is willing to support procurement of all variants).

Summary of changes to the current format, layout and content is as follows:

1. Rewording and restructure of various sections and paragraphs of the specification, plus other editorial changes based on the layout and editorial content of other Detail Specifications already converted to ESCC format.
2. In the Maximum Ratings table amend "Insulation Voltage" to be "Isolation Voltage" (to be consistent with ESCC4001 & ESCC2134000)(in para 1.5).



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3. Figure 1 Parameter Derating Requirements moved to be a note to the Maximum Ratings table (in para 1.5).
4. New para 2.5 for Resistance to Soldering Heat test is added (to be consistent with ESCC 4001)
5. Insulation Resistance test is added to Room Temperature Electrical Measurements (=Table 2) but is guaranteed but not tested during Screening (to be consistent with Para. 2.7)(in para 2.6.1).
6. Para 4.6.2 & Table 3. High & Low Temp Electrical Measurements: change the applied sampling to be a fixed sample of 5 components from the total production lot (to be consistent with ESCC 4001)(in para 2.6.2).
7. Table 4 is deleted (to be consistent ESCC 4001)
8. Figure 5 is deleted.
9. Table 6, Delete drying "Procedure I" reference from Solderability & Resistance to Soldering Heat (to be consistent with ESCC 4001)(in para 2.7).

Justification:

(see also change details for each item above):

Part of the ongoing activity of conversion of ESA/SCC specifications to the ESCC format. Amendments are made to the format and presentation to be consistent with the various other ESCC Detail Specifications, already converted to ESCC format, as well as the latest ESCC Generic Specification No. 4001 issue 2.

Attachments:

4001026Draft3B.pdf, null

Modifications:

In line with Manufacturer (Vishay SA Sfernice/France) request, new Variants 06 to 10 with 'E2' terminal material & finish are added (otherwise identical to Variants 01 to 05 respectively).
Paras 1.4.2, 1.5, 1.6, 2.4 are amended accordingly.

Justification:

new variants requested to be included by Vishay/F

Approval signature:

Date signed:



Pages 1 to 13

RESISTOR, FIXED, CHIP, THICK FILM

BASED ON TYPE CHP

ESCC Detail Specification No. 4001/026

Issue 3 Draft B	March 2009
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DOCUMENTATION CHANGE NOTICE

(Refer to <https://escies.org> for ESCC DCR content)

DCR No.	CHANGE DESCRIPTION
470	Specification updated to incorporate editorial and technical changes per DCR.

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1. GENERAL

1.1 SCOPE

This specification details the ratings, physical and electrical characteristics and test and inspection data for the component type variants and/or the range of components specified below. It supplements the requirements of, and shall be read in conjunction with, the ESCC Generic Specification listed under Applicable Documents.

1.2 APPLICABLE DOCUMENTS

The following documents form part of this specification and shall be read in conjunction with it:

- (a) ESCC Generic Specification No. 4001.

1.3 TERMS, DEFINITIONS, ABBREVIATIONS, SYMBOLS AND UNITS

For the purpose of this specification, the terms, definitions, abbreviations, symbols and units specified in ESCC Basic Specification No. 21300 shall apply.

1.4 THE ESCC COMPONENT NUMBER AND COMPONENT TYPE VARIANTS

1.4.1 The ESCC Component Number

The ESCC Component Number shall be constituted as follows:

Example: 4001026012490F4

- Detail Specification Reference: 4001026
- Component Type Variant Number: 01 (as required)
- Characteristic code: Resistance Value (249Ω): 2490 (as required)
- Characteristic code: Resistance Tolerance (±1%): F (as required)
- Characteristic code: Temperature Coefficient (±100x10⁻⁶/°C): 4 (as required)

1.4.1.1 Characteristics and/or Ratings Codes

Characteristics and/or ratings to be codified as part of the ESCC Component Number shall be as follows:

- (a) Resistance Value expressed by means of the following codes in accordance with ESCC Basic Specification No. 21700. The unit quantity shall be ohm (Ω):

Resistance Value (Ω)	Code
X.XX	XRXX
XX.X	XXRX
XXX	XXX0
XXX 10 ¹	XXX1
XXX 10 ²	XXX2
XXX 10 ³	XXX3

Resistance Value (Ω)	Code
XXX 10 ⁴	XXX4
XXX 10 ⁵	XXX5

(b) Resistance Tolerance expressed by the following codes in accordance with ESCC Basic Specification No. 21700:

Tolerance (\pm %)	Code Letter
1	F
2	G
5	J

(c) Temperature Coefficient expressed by the following codes in accordance with ESCC Basic Specification No. 21700:

Temperature Coefficient ($\pm 10^{-6}/^{\circ}\text{C}$)	Code
100	4
200	6

1.4.2 Component Type Variants and Range of Components

The component type variants and range of components applicable to this specification are as follows:

Variant Number	Style (Note 1)	Resistance Range R _n (Note 2)		Tolerance (\pm %) (Note 2)	Temperature Coefficient TC ($\pm 10^{-6}/^{\circ}\text{C}$) (Note 2)	Critical Resistance (k Ω)	Terminal Material and Finish	Weight max (g)
		Min (Ω)	Max (M Ω)					
01	0603	1	10	1, 2, 5	100, 200	25	E4	0.002
02	0805	1	10	1, 2, 5	100, 200	50	E4	0.004
03	1206	1	10	1, 2, 5	100, 200	160	E4	0.008
04	2010	1	10	1, 2, 5	100, 200	180	E4	0.026
05	2512	1	10	1, 2, 5	100, 200	112.5	E4	0.042
06	0603	1	10	1, 2, 5	100, 200	25	E2	0.002
07	0805	1	10	1, 2, 5	100, 200	50	E2	0.004
08	1206	1	10	1, 2, 5	100, 200	160	E2	0.008
09	2010	1	10	1, 2, 5	100, 200	180	E2	0.026
10	2512	1	10	1, 2, 5	100, 200	112.5	E2	0.042

NOTES:

1. See Physical Dimensions.
- 2.

Resistance (Ω)	Value Series	Available Tolerance ($\pm\%$)	Available Temperature Coefficient ($\pm 10^{-6}/^{\circ}\text{C}$)
$1 \leq R_n < 10$	Any value in the resistance range to 3 significant figures	2, 5	200
$10 \leq R_n < 1\text{M}$		1, 2, 5	100, 200
$R_n \geq 1\text{M}$		2, 5	200

1.5

MAXIMUM RATINGS

The maximum ratings shall not be exceeded at any time during use or storage.

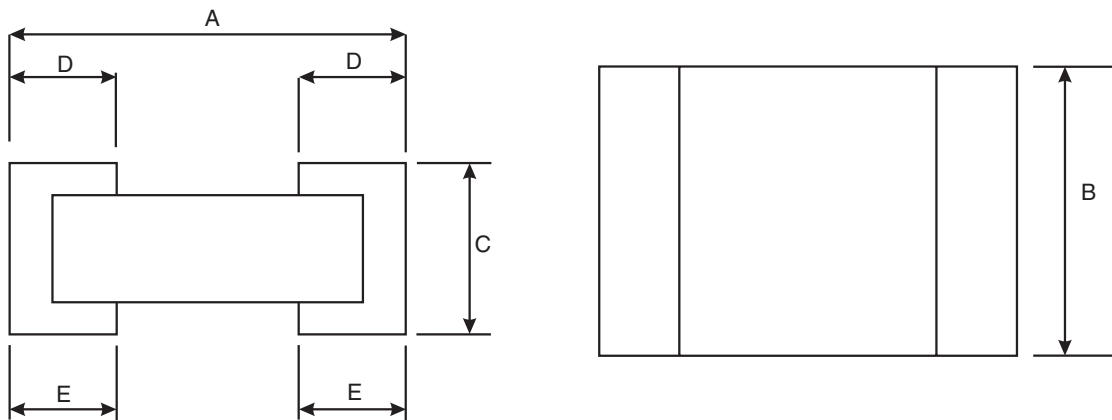
Maximum ratings shall only be exceeded during testing to the extent specified in this specification and when stipulated in Test Methods and Procedures of the ESCC Generic Specification.

Characteristics	Variant Number	Style	Symbols	Limits	Units	Remarks
Rated Dissipation	01, 06	0603	P_n	100	mW	Note 1
	02, 07	0805		200		
	03, 08	1206		250		
	04, 09	2010		500		
	05, 10	2512		800		
Limiting Element Voltage	01, 06	0603	U_L	50	V	-
	02, 07	0805		100		
	03, 08	1206		200		
	04, 09	2010		300		
	05, 10	2512		300		
Rated Voltage	All	All	U_R	$\sqrt{(P_n \times R_n)}$	V	Note 2
Isolation Voltage	01, 06	0603	U_I	100	V	-
	02, 07	0805		200		
	03, 08	1206		300		
	04, 09	2010		300		
	05, 10	2512		300		
Operating Temperature Range	All	All	T_{op}	-55 to +155	$^{\circ}\text{C}$	T_{amb}
Storage Temperature Range	All	All	T_{stg}	-55 to +155	$^{\circ}\text{C}$	-
Soldering Temperature	All	All	T_{sol}	+260	$^{\circ}\text{C}$	Note 3

NOTES:

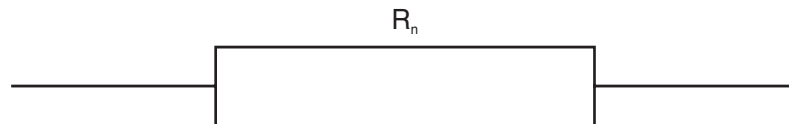
1. At $T_{amb} \leq +70^{\circ}C$. For $T_{amb} > +70^{\circ}C$ derate linearly to 0W at $T_{amb} = +155^{\circ}C$.
2. Shall never exceed Limiting Element Voltage. R_n = Rated Resistance.
3. Duration 10 seconds maximum.

1.6 PHYSICAL DIMENSIONS



Variant Number	Style	Dimensions (mm)							
		A		B		C		D, E	
		Min	Max	Min	Max	Min	Max	Min	Max
01, 06	0603	1.36	1.68	0.72	0.98	0.38	0.53	0.25	0.51
02, 07	0805	1.75	2.07	1.14	1.4	0.38	0.53	0.25	0.51
03, 08	1206	2.89	3.21	1.47	1.73	0.38	0.53	0.25	0.51
04, 09	2010	4.92	5.24	2.41	2.67	0.5	0.63	0.25	0.64
05, 10	2512	6.19	6.51	2.93	3.32	0.5	0.63	0.25	0.64

1.7 FUNCTIONAL DIAGRAM



1.8 MATERIALS AND FINISHES

1.8.1 Body

Each resistive element deposited on the alumina substrate shall be covered with a suitable coating.

1.8.2 Terminations

The terminal material and finish shall be as specified in Component Type Variants and Range of Components in accordance with the requirements of ESCC Basic Specification No. 23500.

2. REQUIREMENTS

2.1 GENERAL

The complete requirements for procurement of the components specified herein are as stated in this specification and the ESCC Generic Specification. Permitted deviations from the Generic Specification, applicable to this specification only, are listed below.

Permitted deviations from the Generic Specification and this Detail Specification, formally agreed with specific Manufacturers on the basis that the alternative requirements are equivalent to the ESCC requirement and do not affect the component's reliability, are listed in the appendices attached to this specification.

2.1.1 Deviations from the Generic Specification

2.1.1.1 *Deviations from Screening Tests (Chart F3)*

(a) Para. 8.2, Non-Linearity: Not applicable.

2.1.1.2 *Deviations from Qualification and Periodic Tests (Chart F4)*

(a) Para. 8.9, Vibration: Not applicable.

2.2 MARKING

The marking of all components delivered to this specification shall be in accordance with the requirements of ESCC Basic Specification No. 21700. When the component is too small to accommodate all of the marking specified, as much as space permits shall be marked and the marking information, in full, shall accompany each component in its primary package.

The information to be marked and the order of precedence, shall be as follows:

- (a) The ESCC qualified components symbol (for ESCC qualified components only).
- (b) The ESCC Component Number.
- (c) Traceability information.

2.3 OVERLOAD

The test conditions for Overload, tested as specified in the ESCC Generic Specification, shall be as follows:

Voltage:	$\sqrt{6.25P_n \times R_n}$ or $2U_L$, whichever is less.
Duration:	2s minimum.

2.4 ROBUSTNESS OF TERMINATIONS - SUBSTRATE BENDING TEST

The test conditions for the Substrate Bending Test, tested as specified in the ESCC Generic Specification, shall be as follows:

Number of bends:	10.
Deflection:	2mm (Variants 01, 02, 03, 06, 07, 08) 1mm (Variants 04, 05, 09, 10)
Duration:	5±1s

2.5 RESISTANCE TO SOLDERING HEAT

The test conditions for Resistance to Soldering Heat, tested as specified in the ESCC Generic Specification, shall be as follows:

Temperature:	260°C
Duration:	10(+0-1)s

2.6 ELECTRICAL MEASUREMENTS AT ROOM, HIGH AND LOW TEMPERATURES

2.6.1 Room Temperature Electrical Measurements

The measurements shall be performed at $T_{amb}=+22 \pm 3^{\circ}C$.

Characteristics	Symbols	ESCC 4001 Test Method and Conditions	Tolerance (± %)	Limits		Units
				Min	Max	
Resistance	R_A	Para. 8.3.1.1	1	0.99 R_n	1.01 R_n	Ω
			2	0.99 R_n	1.02 R_n	
			5	0.95 R_n	1.05 R_n	
Insulation Resistance	R_I	Para. 8.3.1.2 V=100V Note 1	All	1000	-	M Ω

NOTES:

1. Guaranteed but not tested during Screening Tests.

2.6.2 High and Low Temperatures Electrical Measurements

Characteristics	Symbols	ESCC 4001 Test Method and Conditions (Note 1)	Limits		Units
			Min	Max	
Resistance Change between -55 (+3-0)°C and +22 ± 3°C	$\Delta R_A/R_A$	Para. 8.3.1.1 TC = ±100 x 10 ⁻⁶ /°C	-0.8	+0.8	%
		TC = ±200 x 10 ⁻⁶ /°C	-1.6	+1.6	
Resistance Change between +155 (+0 -3)°C and +22 ± 3°C	$\Delta R_A/R_A$	Para. 8.3.1.1 TC = ±100 x 10 ⁻⁶ /°C	-1.36	+1.36	%
		TC = ±200 x 10 ⁻⁶ /°C	-2.72	+2.72	

NOTES:

- The measurements shall be performed on a sample of 5 components selected from the total production lot.

2.7 INTERMEDIATE AND END-POINT ELECTRICAL MEASUREMENTS

The components shall be mounted as specified in the ESCC Generic Specification.

Unless otherwise specified, the measurements shall be performed at T_{amb}=+22 ±3°C.

Unless otherwise specified the test methods and test conditions shall be as per the corresponding test defined in Room Temperature Electrical Measurements.

Test Reference per ESCC No. 4001	Characteristics	Symbols	Limits		Units
			Min	Max	
Rapid Change of Temperature Initial Measurement Final Measurement	Resistance Change in Resistance	R_A $\Delta R_A/R_A$	Record Values ±(0.25 + 0.05Ωx100/R _n)		%
Robustness of Terminations Initial Measurement Final Measurement	Resistance Change in Resistance	R_A $\Delta R_A/R_A$	Record Values ±(0.25 + 0.05Ωx100/R _n)		%
Resistance to Soldering Heat Initial Measurement Final Measurement	Resistance Change in Resistance	R_A $\Delta R_A/R_A$	Record Values ±(0.5 + 0.05Ωx100/R _n)		%
Solderability Initial Measurement	Resistance	R_A	Record Values		

Test Reference per ESCC No. 4001	Characteristics	Symbols	Limits		Units
			Min	Max	
Final Measurement	Change in Resistance	$\Delta R_A/R_A$	$\pm(0.25 + 0.05\Omega \times 100/R_n)$		%
Climatic Sequence					
Initial Measurements (Procedure 1)	Resistance (after drying)	R_A	Record Values		
Final Measurements	Change in Resistance	$\Delta R_A/R_A$	$\pm(1 + 0.05\Omega \times 100/R_n)$		%
	Insulation Resistance ($V_T=100V$)	R_I	1000	-	M Ω
Operating Life					
Initial Measurement (0 hour)	Resistance	R_A	Record Values		
Intermediate Measurements (1000 hours)	Change in Resistance	$\Delta R_A/R_A$	$\pm(1 + 0.05\Omega \times 100/R_n)$		%
Final Measurements (2000 hours)	Change in Resistance	$\Delta R_A/R_A$	$\pm(1.5 + 0.05\Omega \times 100/R_n)$		%
	Insulation Resistance ($V_T=100V$)	R_I	1000	-	M Ω

2.8 BURN-IN CONDITIONS

Characteristics	Symbols	Test Conditions	Units
Ambient Temperature	T_{amb}	+70 \pm 3	$^{\circ}C$
Test Voltage	V_T	$\sqrt{(P_n \times R_n)}$ or U_L whichever is less	V

NOTES:

1. After Burn-in, the components shall be removed from the chamber and allowed to cool under normal atmospheric conditions for a minimum of 4 hours.

2.9 OPERATING LIFE CONDITIONS

The conditions shall be as specified for Burn-in.

APPENDIX A**AGREED DEVIATIONS FOR VISHAY SFERNICE (F)**

Items Affected	Description of Deviations
Deviations from Generic Specification: Production Control (Chart F2) Qualification and Periodic Tests (Chart F4)	Para. 5.2.1, Dimension Check: Guaranteed but not tested. Para. 8.1, Permanence of Marking: Not applicable.